

ISLPED 2016

INTERNATIONAL SYMPOSIUM ON LOW POWER ELECTRONICS AND DESIGN

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The International Symposium on Low Power Electronics and Design (ISLPED) is the premier forum for the presentation of innovative research in all aspects of low power electronics and design, ranging from process technologies and analog/digital circuits, simulation and synthesis tools, system-level design and software **targeting applications in communication, automotive, consumer, biomedical and industrial markets**. **ISLPED 2016 will include a design contest and several invited presentations from industry.**

ISLPED is coming back to the Silicon Valley and the 2016 edition will be held at the Hyatt Regency, San Francisco Airport. ISLPED invites industrial sponsors to participate in the conference and engage with all the attendees. Various levels of sponsorships are available and industrial sponsors will be acknowledged at the conference with the following benefits:

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